



A5N:300.XXH

VOLTAGE RATINGS

Part Number	V_{RRM} , V_R (V) Max. rep. peak reverse voltage		V_{RSM} , V_R (V) Max. non-rep. peak reverse voltage
	$T_J = 0$ to 125°C	$T_J = -40$ to 0°C	
	$T_J = 25$ to 125°C		
A5N:300.12H	1200	1200	1300
A5N:300.14H	1400	1400	1500
A5N:300.16H	1600	1600	1700
A5N:300.18H	1800	1800	1900
A5N:300.20H	2000	2000	2100

MAXIMUM ALLOWABLE RATINGS

PARAMETER	VALUE	UNITS	NOTES
T_J Junction Temperature	-40 to 125	$^\circ\text{C}$	-
T_{stg} Storage Temperature	-40 to 150	$^\circ\text{C}$	-
$I_{T(AV)}$ Max. Av. current @ Max. T_C	300	A	180° half sine wave
	75	$^\circ\text{C}$	
$I_{T(RMS)}$ Nom. RMS current	470	A	-
I_{TSM} Max. Peak non-rep. surge current	4.53	kA	50 Hz half cycle sine wave Initial $T_J = 125^\circ\text{C}$, rated V_{RRM} applied after surge.
	4.94		60 Hz half cycle sine wave
	5.23		50 Hz half cycle sine wave Initial $T_J = 125^\circ\text{C}$, no voltage applied after surge.
	5.70		60 Hz half cycle sine wave
I^2t Max. I^2t capability	109	kA^2s	$t = 10\text{ms}$ Initial $T_J = 125^\circ\text{C}$, rated V_{RRM} applied after surge.
	119		$t = 8.3\text{ms}$
	125		$t = 10\text{ms}$ Initial $T_J = 125^\circ\text{C}$, no voltage applied after surge.
	136		$t = 8.3\text{ms}$
$I^{2,1/2}$ Max. $I^{2,1/2}$ capability	1490	$\text{kA}^2\text{s}^{1/2}$	Initial $T_J = 125^\circ\text{C}$, no voltage applied after surge. I^2t for time $t_x = I^{2,1/2} * t_x^{1/2}$. ($0.1 < t_x < 10\text{ms}$).
di/dt Max. Non-repetitive rate-of-rise current	800	A/ s	$T_J = 125^\circ\text{C}$, $V_D = V_{DRM}$, $I_{TM} = 1600\text{A}$. Gate pulse: 20V, 20 , 10 s, 0.5 s rise time, Max. repetitive di/dt is approximately 40% of non-repetitive value.
P_{GM} Max. Peak gate power	10	W	$t_p < 5\text{ms}$
$P_{G(AV)}$ Max. Av. gate power	3	W	-
$+I_{GM}$ Max. Peak gate current	150	mA	$t_p < 5\text{ms}$
$-V_{GM}$ Max. Peak negative gate voltage	2	V	-
F Mounting Force	450	N.m	-



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CHARACTERISTICS

PARAMETER	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
V_{TM} peak on-state voltage	---	---	1.93	V	Initial $T_J = 25^\circ\text{C}$, 50-60Hz half sine, $I_{peak} = 924\text{A}$.
$V_{T(TO)}$ Threshold voltage	---	---	0.88	V	$T_J = 125^\circ\text{C}$ Av. power = $V_{T(TO)} * I_{T(AV)} + r_T * [I_{T(RMS)}]^2$, 180° Half Sine.
r_T Slope resistance	---	---	1.28	m	Use low values for $I_{TM} <$ rated $I_{T(AV)}$
I_L Latching current	---	---	400	mA	$T_C = 125^\circ\text{C}$, 12V anode. Gate pulse: 10V, 20 , 100 s.
I_H Holding current	---	---	500	mA	$T_C = 25^\circ\text{C}$, 12V anode. Initial $I_T = 15\text{A}$.
t_d Delay time	---	0.7	1	s	$T_C = 25^\circ\text{C}$, $V_D = V_{DRM}$, 50A resistive load. Gate pulse: 10V, 20 , 10 s, 1 s rise time.
t_q Turn-off time	---	---	100	s	$T_J = 125^\circ\text{C}$, $I_{TM} = 550\text{A}$, $di/dt = 40\text{A/s}$, $V_R = 50\text{V}$. $dv/dt = 20\text{V/s}$ lin. to rated V_{DRM} . Gate: 0V, 100 .
dv/dt Critical rate-of-rise of off-state voltage	---	---	1000	V/ s	$T_J = 125^\circ\text{C}$, Exp. To 67% V_{DRM} , gate open.
I_{RM} , I_{DM} Peak reverse and off-state current	---	15	30	mA	$T_J = 125^\circ\text{C}$, Rated V_{RRM} and V_{DRM} , gate open.
I_{GT} DC gate current to trigger	---	---	360	mA	$T_C = -40^\circ\text{C}$ $T_C = 25^\circ\text{C}$ +12V anode-to-cathode. For recommended gate drive see "Gate Characteristics" figure.
	---	---	180		
V_{GT} DC gate voltage to trigger	6	---	---	V	$T_C = -40^\circ\text{C}$ $T_C = 25^\circ\text{C}$
	3	---	---		
V_{GD} DC gate voltage not to trigger	---	---	0.3	V	$T_C = 25^\circ\text{C}$, Max. Value which will not trigger with rated V_{DRM} anode.
R_{thJC} Thermal resistance, junction-to-case	---	---	0.085	$^\circ\text{C/W}$	DC operation, double side cooled.
	---	---	0.106	$^\circ\text{C/W}$	180° sine wave, double side cooled.
	---	---	0.109	$^\circ\text{C/W}$	120° rectangular wave, double side cooled.
R_{thCS} Thermal resistance, case-to-sink	---	---	0.03	$^\circ\text{C/W}$	Mtg. Surface smooth, flat and greased. Double side cooled.
wt Weight	---	57(2.1)	---	g(oz.)	---
Case Style	TO-200AA			JEDEC	---

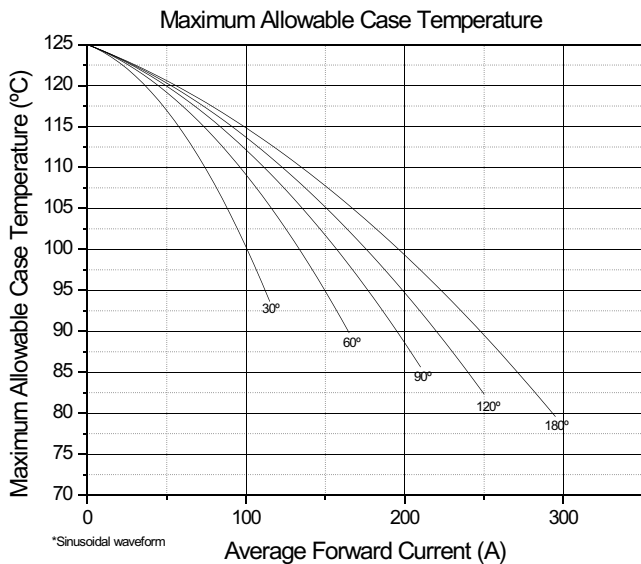


Fig. 1 - Current Ratings Characteristics

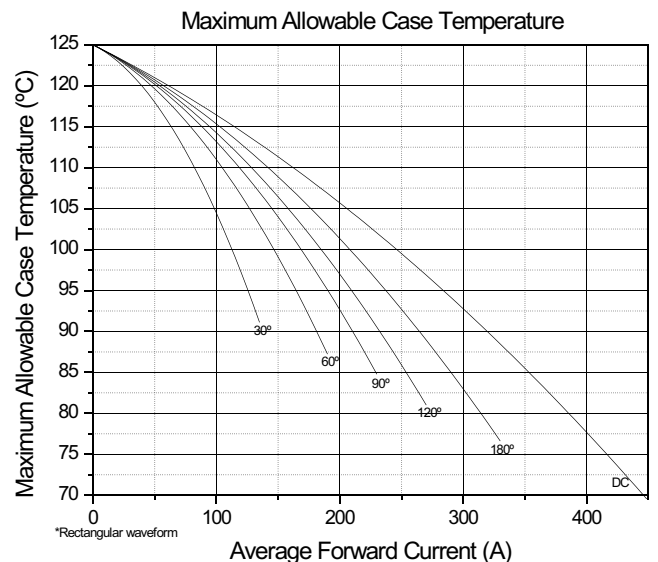


Fig. 2 - Current Ratings Characteristics



A5N:300.XXH

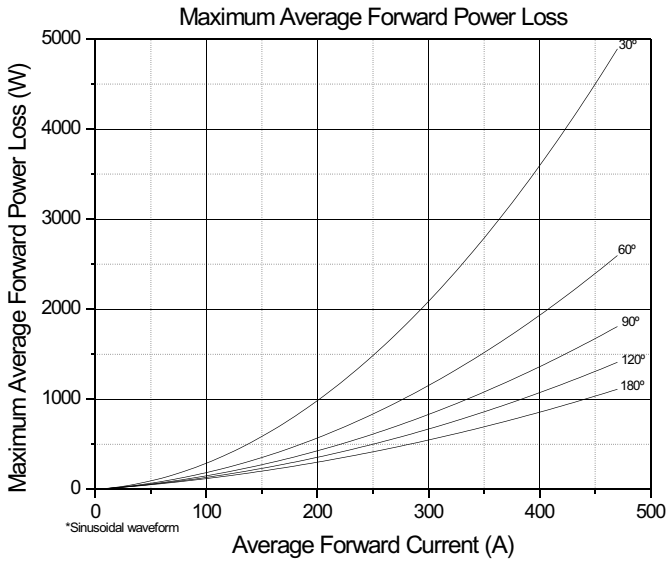


Fig. 3 - Forward Power Loss Characteristics

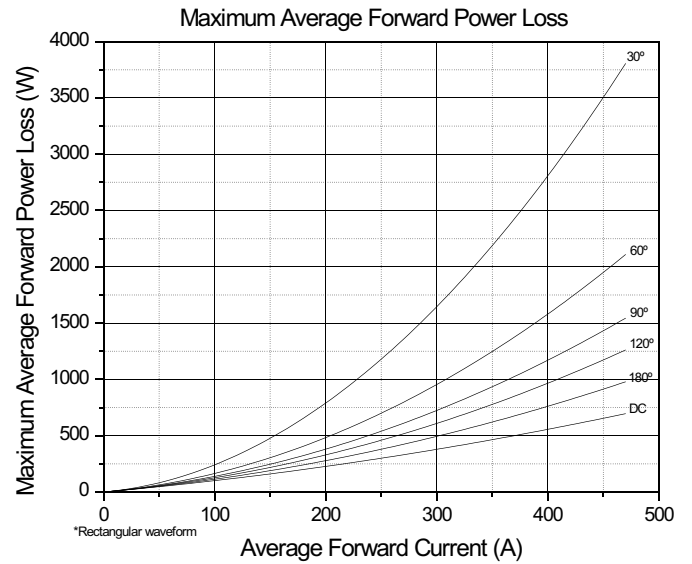


Fig. 4 - Forward Power Loss Characteristics

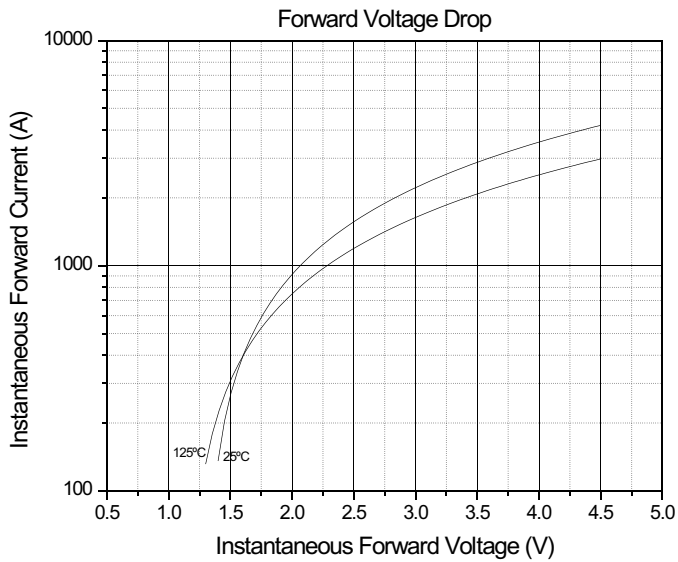


Fig. 5 - Forward Voltage Drop Characteristics

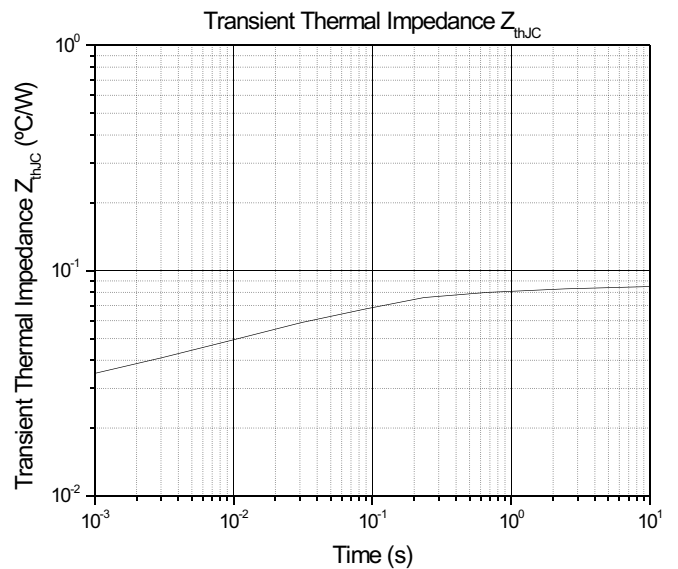


Fig. 6 - Transient Thermal Impedance Characteristics



A5N:300.XXH

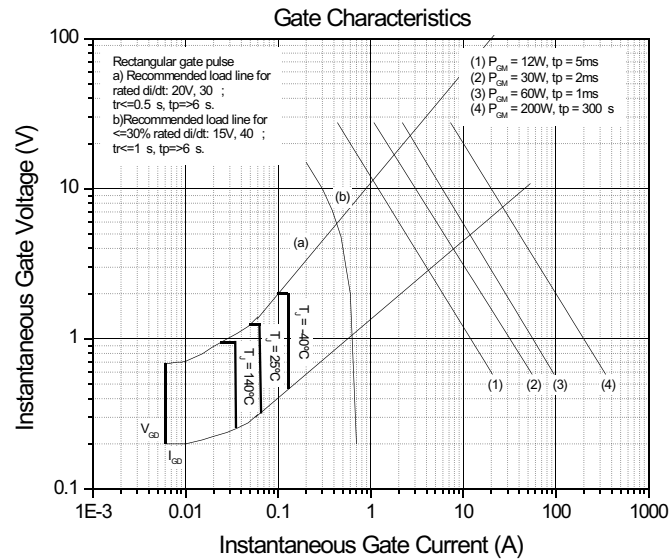


Fig. 7 - Gate Trigger Characteristics

TO-200AA

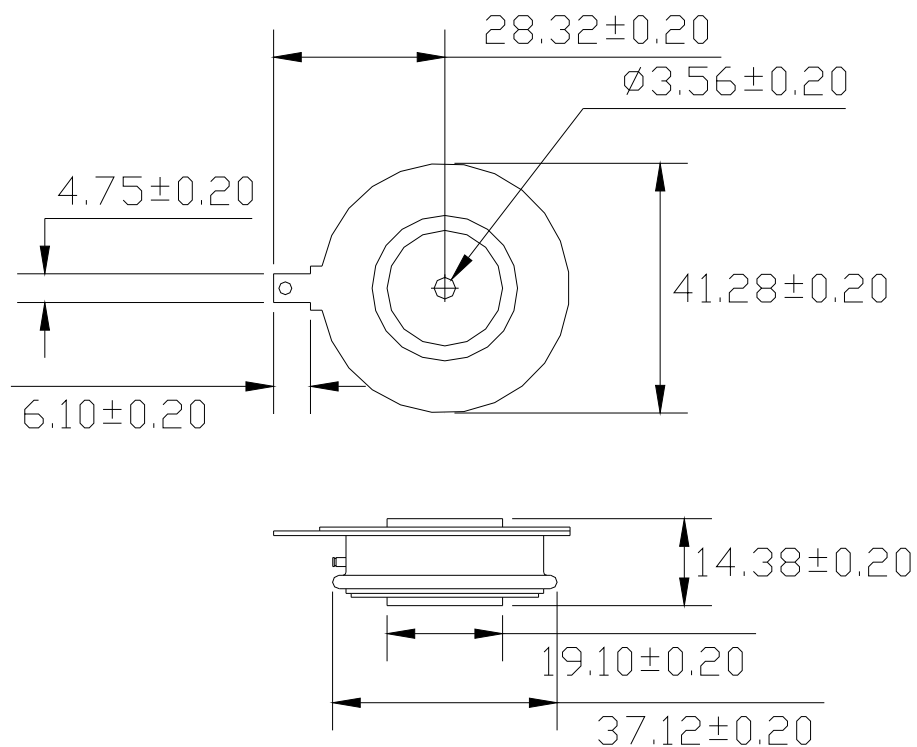


Fig. 8 - Outline Characteristics